AC-LGAD TOF for ATHENA

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Low pT PID for Physics Measurements at EIC Exclusive φ (Z. Tu) Λ_c (W. Fan)





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AC-LGAD TOF Detectors in ATHENA DD4HEP



Barrel TOF (Area=6.28m²) Z=[-1m, 1m], R=0.5m, Eta=[-1.44, 1.44]

Forward TOF (Area= $5.44m^2$) Z=1.73m, R_{in}=0.19m, R_{out}=0.95m Eta=[1.36, 2.91]

Backward TOF (Area= $5.44m^2$) Z=-1.85m, R_{in}=0.19cm, R_{out}=0.95m, Eta=[-2.97,-1.42]



ATHENA Baseline 2.0 Tracker – Nick Lukow (10/5/2021)

Barrel layout



 0.55% X/X0 might be conservative; Rey showed significant performance improvement for lower material in these layers; material optimisations to be looked into considering RD104 services reduction, inputs from engineers, etc. not necessarily for the proposal

- Si pixel pitch 10 um for vtx and barrel layers
- Si Vertex
 Radius (mm)
 Length (cm) × X/XO

 Layer 1
 33
 28
 0.05

 Layer 2
 44.1
 28
 0.05

 Layer 3
 55.1
 28
 0.05
- Three vtx layers for redundancy and low pTthreshold
- Radii from 1st engineering CAD model release based on possible stitched sensor size in phi
 Length = 28 cm: max length of a single sensor
- on wafer, allows for services on one side only; helps low material in negative direction

rrel MPGD acker (MM)	Radius (cm)	Length (cm)	Area (m^2)	Resolution (um)	% X/X0
er 1	47.72	127.47	3.82		
er 2	49.57	127.47	3.97	150	0.4
er 3	75.61	201.98	9.59	150	0.4
er 4	77.47	201.98	9.83		

- Cheaper than silicon, no detrimental effect on performance
- Further optimisation of number of layers requires pattern recognition in presence of background, not for the proposal

Barrel MPGD

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Barrel layout

Layer 2



48.08

0.55

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Si Vertex	Radius (mm)	Length (cm) % X/X0
Laver 1	33	2	8 0

Si pixel pitch 10 um for vtx and barrel layers

- Layer 2 Layer 3
 44.1 55.1
 28 28
 0.05 0.05

 • Three vtx layers for redundancy and low pT
- threshold
 Radii from 1st engineering CAD model release based on possible stitched sensor size in phi
- Length = 28 cm: max length of a single sensor on wafer, allows for services on one side only; helps low material in negative direction

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Additional Barrel Single Layer AC-LGAD Z=[-1m, 1m], R=0.5m, Area=6.28m², Eta=[-1.44, 1.44] Strip pitch: 500 um in R φ , 2.5 cm in Z Spatial resolution: <u>15 um in R φ </u>, 2.5/sqrt(12) cm in Z Material budget: <u>1.1%X</u>₀

10/12/21



Laser study: position resolution as a function of pixel geometry



RSDs reach a spatial resolution that is about 5% of the inter-pad distance

 \Rightarrow ~ 5 µm resolution with 150 µm pitch

RSDs have the "usual" UFSD temporal resolution of 30-40 ps

2021

AC-LGAD Barrel TOF Detector for EIC – STAR IST





1) carbon foam 2) carbon honeycomb 3) west carbon end-cap 4) east Al end-cap 5) carbon fiber skins 6) Kapton hybrid 7) Al cooling tube with cooling liquid inside 8) thermal sensor 9) silicon sensors 10) APV chips 11) support blocks 12) screws with washers 13) spacers 14) transition board 15) readout connectors.

AC-LGAD Endcap TOF Detectors for EIC – STAR IST



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ATHENA Baseline 2.0 Tracker + Barrel AC-LGAD



Adding the proposed Barrel AC-LGAD layer (e.g. 500 microns pitch perpendicular to the beam direction and $\sim 1\% X_0$) can improve high momentum resolution

ATHENA Baseline 2.0 Tracker + Barrel AC-LGAD



ATHENA Baseline 2.0 Tracker + Barrel AC-LGAD



Conclusion

Adding an AC-LGAD TOF layer in the Barrel region at R~50cm can

- Provide low-p PID below DIRC threshold at small R (necessary in removing ρ contamination for exclusive ϕ)
- Do not degrade significantly the momentum resolution at low momentum and significantly improve the momentum resolution at high momentum (based on Baseline2.0 tracker design)



Backup

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AC-LGAD for EIC

- Large area LGAD detectors are being built by ATLAS (6.4 m²) and CMS (14 m²) for data taking starting in 2026.
- AC LGAD detectors proposed for EIC
 - Roman Pots and B0
 - TOF for PID (and tracking)
- Have common designs in sensor, ASIC etc. when possible, combine R&D efforts



	Time resolution / hit	Position resolution / hit	Material budget / layer
Barrel ToF (Tracker)	<30 ps	(3-30 μm for Tracker)	$< 0.01 X_0$
Endcap ToF (Tracker)	<25 ps	(30-50 μm for Tracker)	e-direction $< 0.05X_0$
			h-direction $< 0.15 X_0$
Roman Pots	< 50 ps	$< 500/\sqrt{12} \ \mu m$	N/A
B0	< 50 ps	$O(50) \ \mu m$	$< 0.01 X_0$

Sensor R&D

Comparison WF2 Simulation - Data Band bars show variation with temperature (T = -20C - 20C), and gain (G = 20 -30) 20 200 FBK - PIN (NA62) 180 FBK - UFSD 15 160 HPK - UFSD 140 -WF2: Jitter+Landau - UFSD 120 •••••WF2: Jitter - UFSD 10 100 --WF2: Landau - UFSD 80 60



R&D Goals

- 15-20 ps timing resolution, $O(3-50\mu m)$ position resolution where needed
- Minimal readout channel density (long strip, rectangular pixel) for reduced power and thus material and cost
- Plan

Resolution [ps]

40 20 0

0

- Produce and test sensors with thinner active volume to achieve the desired timing resolution
- Optimize implantation parameters and AC-pad segmentation through simulation and real device studies
- Engage commercial vendors to improve fabrication process and yield

ATHENA Tracker Baseline 2.0 - Material Scan

